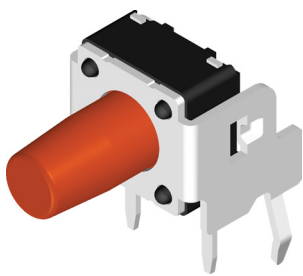


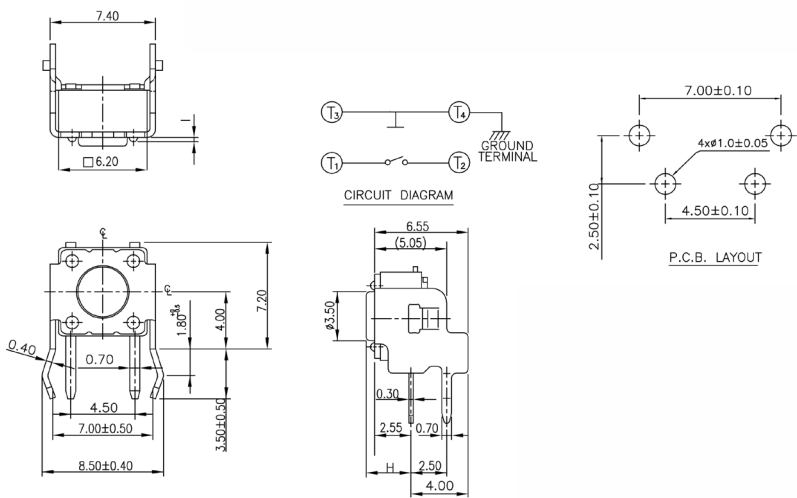
Tactile Switch

multicomp^{PRO}

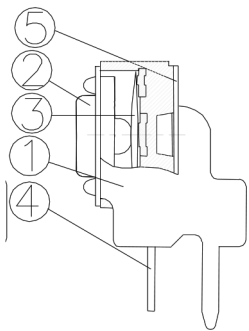
RoHS
Compliant



Diagram



Item	Description	Q'ty	Materials	Treatment
1	Cover	1	Steel	With tin plating
2	Stem		Thermoplastic Nylon UL 94V-0	--
3	Contact		Phosphor Bronze	With silver plating
4	Terminal		Brass	
5	Base		Thermoplastic Nylon UL 94V-0	--



multicomp^{PRO}

1. Style

This specification describes "TACTILE SWITCH", mainly used as signal switch of electric devices, with the general requirements of mechanical and electrical characteristic.

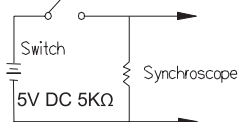
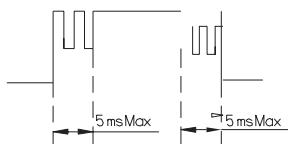
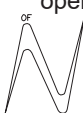
1.1 Operating Temperature Range: -25°C+70°C

1.2 Storage Temperature Range : -30°C+80°C

2. **Current Range:** 50mA, 12V DC

3. **Type of Actuation:** Tactile feedback

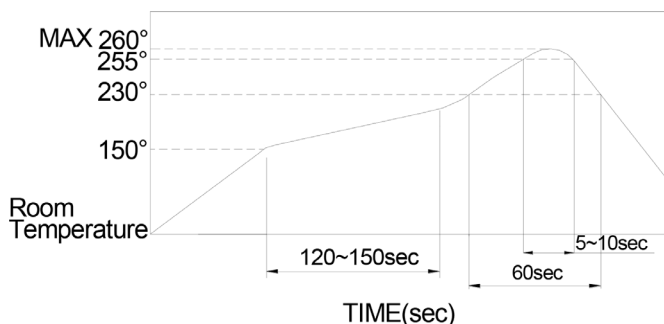
4. **Test Sequence:**

Item	Description	Test Conditions	Requirements					
Appearance								
1	Visual Examination	By visual examination check without any out pressure & testing.	There shall be no defects that affect the serviceability of the product.					
Electric Performance								
2	Contact Resistance	Applying a static load 1.5~2 times the operating force to the center made with a 1 kHz small current contact resistance meter.	100mΩ Max.					
3	Insulation Resistance	Measurements shall be made following application of 500V DC potential across terminals and cover for 1 minute ±5 seconds	100MΩ Min.					
4	Dielectric Withstanding Voltage	250 V AC(50Hz or 60Hz) shall be applied across terminals and cover for 1 minute	There shall be no breakdown or flashover.					
5	Bounce	3 to 4 operations at a rate of 1 cycles per second 	5 m seconds Max. 					
Mechanical Performance								
6	Operating Force	Applied in the direction of operation. 	OF					
			U	K	N	R	S	Y
			70±30 [69N±29N]	100±50 [98N±49N]	160±50 [1568N±49N]	260±50 [2548N±49N]	320±80 [3.136N±784N]	520±130 [5.096N±1274N]

7	Stroke	Placing the switch such that the direction of switch operation is vertical and then gradually increasing the load applied to the stem, the stroke distance for the stem to come to a stop shall be measured.	0.25 +0.2/-0.1mm
8	Stop Strength	Placing the switch such that the direction of switch operation is vertical, a static load of 3 kgf (29.4N) shall be applied in the direction of stem operation for a period of 15 seconds	1. As shown in item 4~7 2. Contact Resistance: 200mΩ Max 3. Insulation Resistance: 10MΩ Min
9	Solder Heat Resistance	(Through Hole Type (Soldering Temperature: 260 ±5°C (Duration of Solder Immersion: 5 ± 1 seconds. (Frequency of Soldering Process 2 times max. (PCB is 1.6mm in thickness) SMT Type ~DTSM Series(4/4)	1. Shall be free from pronounced backlash and falling-off or breakage terminals 2. As shown in item 4, 5 3. Contact Resistance: 200mΩ Max 4. Insulation Resistance: 10MΩ Min
10	Vibration	Shall be vibrated in accordance with Method 201A of MIL-STD-202F 1. Frequency: 10-55-10Hz in 1-min/ cycle. 2. Direction: 3 vertical directions including the directions of operation 3. Test time: 2 hours each direction. 4. Swing distance=1.5mm	1. As shown in item 4~7 2. Contact Resistance: 200mΩ Max 3. Insulation Resistance: 10MΩ Min
11	Shock	Shall be shocked in accordance with Method 213B condition A of MIL-STD-202F 1) Acceleration: 50G 2) Action time: 11±1m seconds 3) Testing Direction: 6 sides 4) Test Cycle: 3 times in each direction	1) As shown in item 4~7 2) Contact Resistance: 200mΩ Max 3) Insulation Resistance: 10MΩ Min
12	Solder ability	Through Hole Soldering 1) Temperature: 245±3°C Lead-Free solder: M705E JIS Z 3282 A (Tin 96.5%, Silver 3%, Copper 0.5%) 2) Flux: 5~10 sec 3) Duration of solder Immersion: 5±1 sec	No anti-soldering and the coverage of dipping into solder must more than 66% was requested.

Durability			
13	Operating Life	<p>Measurements shall be made following the test forth below:</p> <p>1) 5 mA, 5V DC resistive load</p> <p>2) Applying a static load the operating force to the center of the stem in the direction of operation</p> <p>3) Cycle of Operation: (Through Hole, S.M.T Dome=Phosphor Bronze)</p> <p>200,000 cycle's Min. For 100,160gf</p> <p>100,000 cycle's Min. For 260gf</p> <p>50,000 cycle's Min. For 320,520gf (S.M.T Dome=Stainless Steel)</p> <p>1,000,000 cycle's Min~100,160gf</p> <p>500,000 cycle's Min~260gf</p> <p>300,000 cycle's Min~320, 520gf</p>	<p>1) As shown in item 4, 5</p> <p>2) Operating force:±50% of initial force.</p> <p>3) Contact Resistance: 10Ω Max</p> <p>4) Insulation Resistance: 10MΩ Min</p> <p>5) Bounce: 10 m seconds Max</p>
Weather-Proof			
14	Resistance Low Temperature	<p>Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before the measurements are made:</p> <p>1) Temperature:-25±3°C</p> <p>2) Time:96 hours</p>	<p>1) As shown in item 4~7</p> <p>2) Contact Resistance: 200mΩ Max</p> <p>3) Insulation Resistance: 10MΩ Min</p>
15	Resistance High Temperature	<p>Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before the measurements are made:</p> <p>1) Temperature:80±2°C</p> <p>2) Time:96 hours</p>	<p>1) As shown in item 4~7</p> <p>2) Contact Resistance: 200mΩ Max</p> <p>3) Insulation Resistance: 10MΩ Min</p>
16	Resistance Humidity	<p>Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before the measurements are made:</p> <p>1) Temperature:40±2°C</p> <p>2) Relative Humidity:90~95%</p> <p>3) Time:96 hours</p>	<p>1) As shown in item 4~7</p> <p>2) Contact Resistance: 200mΩ Max</p> <p>3) Insulation Resistance: 10MΩ Min</p>

Soldering Conditions



- The condition mentioned above is the temperature on the Cu foil of the PCB surface. There are cases where board's temperature greatly differs from switch's surface be used not to allow switch's surface temperature to exceed 260°C.

Manual Soldering

Soldering Temperature Max.350°C
Continuous Soldering Time Max. 5 seconds

Part Number Table

Description	Part Number
Tactile Switch, Through Hole, 7.4mm × 7.1mm, H3.15mm 100gf	MPDTSA-61K-V
Tactile Switch, Through Hole, 7.4mm × 7.1mm, H5.85mm 100gf	MPDTSA-63K-V
Tactile Switch, Through Hole, 7.4mm × 7.1mm, H5.85mm 160gf	MPDTSA-63N-V

Important Notice : This data sheet and its contents (the "Information") belong to the members of the AVNET group of companies (the "Group") or are licensed to it. No licence is granted for the use of it other than for information purposes in connection with the products to which it relates. No licence of any intellectual property rights is granted. The Information is subject to change without notice and replaces all data sheets previously supplied. The Information supplied is believed to be accurate but the Group assumes no responsibility for its accuracy or completeness, any error in or omission from it or for any use made of it. Users of this data sheet should check for themselves the Information and the suitability of the products for their purpose and not make any assumptions based on information included or omitted. Liability for loss or damage resulting from any reliance on the Information or use of it (including liability resulting from negligence or where the Group was aware of the possibility of such loss or damage arising) is excluded. This will not operate to limit or restrict the Group's liability for death or personal injury resulting from its negligence. Multicomp Pro is the registered trademark of Premier Farnell Limited 2019.